# Hyper Fast Rectifier, 8 A FRED Pt<sup>®</sup>



DPAK (	TO-252AA
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PRIMARY CHARACTERISTICS								
Package	DPAK (TO-252AA)							
I <sub>F(AV)</sub>	8 A							
V <sub>R</sub>	600 V							
V <sub>F</sub> at I <sub>F</sub>	1.3 V							
t <sub>rr</sub> (typ.)	18 ns							
T <sub>J</sub> max.	175 °C							
Circuit configuration	Single die							

### **FEATURES**

- Hyper fast recovery time, reduced Q<sub>rr</sub> and soft recovery
- 175 °C maximum operating junction temperature
- For PFC CRM/CCM operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **DESCRIPTION / APPLICATIONS**

State of the art hyper fast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS inverters or as freewheeling diodes. Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Peak repetitive reverse voltage	V <sub>RRM</sub>		600	V						
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 143 °C	8							
Non-repetitive peak surge current	I <sub>FSM</sub>	T <sub>J</sub> = 25 °C	90	А						
Peak repetitive forward current	I <sub>FM</sub>	$T_{C} = 143 \text{ °C}, f = 20 \text{ kHz}, d = 50 \text{ \%}$	16							
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C						

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	Ι <sub>R</sub> = 100 μΑ	600	-	-				
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 8 A	-	2.0	2.4	V			
Forward voltage		I <sub>F</sub> = 8 A, T <sub>J</sub> = 150 °C	-	1.3	1.8				
Povoroo lookago ourront		V <sub>R</sub> = V <sub>R</sub> rated	-	-	50	μA			
Reverse leakage current	I <sub>R</sub>	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	500	μΑ			
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	8	-	pF			
Series inductance	Ls	Measured lead to lead 5 mm from package body	-	8	-	nH			

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RoHS

COMPLIANT

HALOGEN

FREE





<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		$I_F = 1 \text{ A}, dI_F/dt = 50$	0 A/μs, V <sub>R</sub> = 30 V		21					
	+	$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 10$	-	18	22	ns				
	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	25	-	- A			
		T <sub>J</sub> = 125 °C	I <sub>F</sub> = 8 A dI <sub>F</sub> /dt = 200 A/µs V <sub>R</sub> = 390 V	-	34	-				
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	3.3	-				
Peak recovery current		T <sub>J</sub> = 125 °C		-	4.8	-				
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	39	-				
		T <sub>J</sub> = 125 °C		-	90	-	nC			

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C			
Thermal resistance, junction to case per leg	R <sub>thJC</sub>		-	1.8	2.2	°C/W			
A			0.3			g			
Approximate weight				0.01		oz.			
Marking device		Case style TO-252AA (D-PAK)	8EWH06FN						

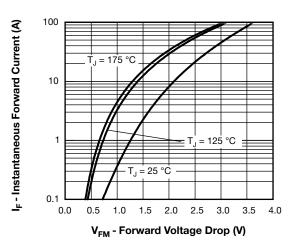


Fig. 1 - Typical Forward Voltage Drop Characteristics

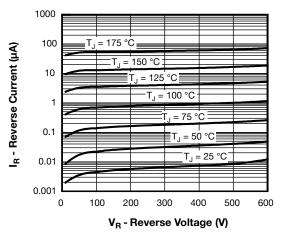


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



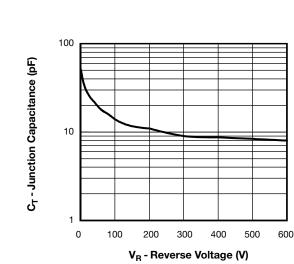


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

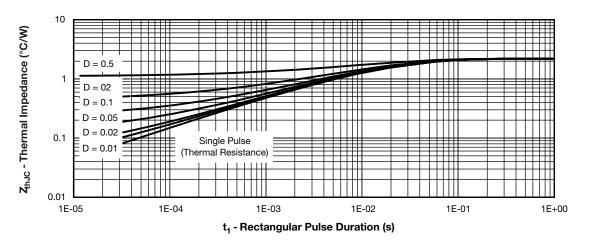
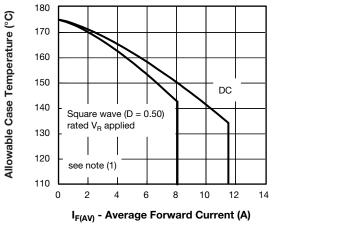
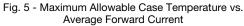


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics



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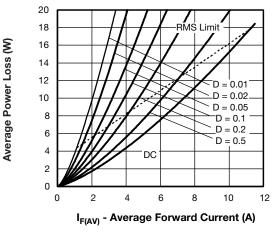


Fig. 6 - Forward Power Loss Characteristics

Revision: 06-Jun-17

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Document Number: 93238

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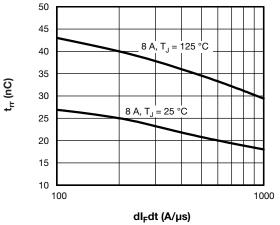
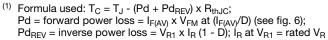


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt





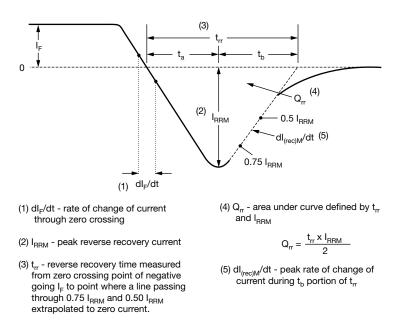
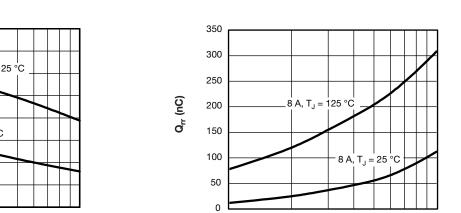


Fig. 9 - Reverse Recovery Waveform and Definitions



100

dl<sub>F</sub>dt (A/µs) Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

VS-8EWH06FN-M3

## **Vishay Semiconductors**

1000

**ORDERING INFORMATION TABLE** 

Device code	VS-	8	Е	w	н	06	FN	TRL	-МЗ
			<u> </u>		<u> </u>				
		$\begin{pmatrix} 1\\ 2 \end{pmatrix}$	(3)	$\begin{pmatrix} 4 \end{pmatrix}$	5	6	(7)	(8)	(9)
		Viel		ioonduu	toro pr	- du at	_	_	-
			-	niconduc	-	Jauci			
				ng (8 =					
	3	- Circ	cuit conf	iguratior	ר:				
		E =	single of	liode					
	4	- Pac	kage id	entifier:					
		VV =	= D-PAK	ζ.					
	5	- н=	hyperfa	st recov	very				
	6	- Vol	tage rati	ng (06 =	= 600 V)				
	7	- FN	= TO-25	52AA					
	8	• N	one = tu	ıbe					
	—	• T	R = tape	e and ree	əl				
		• T	RL = tap	e and re	eel (left	oriented	d)		
		• TI	RR = tap	be and r	eel (righ	nt orient	ed)		
	9	- Env	vironmer	ntal digit	:				
		-M3	3 = Halo	gen-free	e, RoHS	-compli	ant, and	d termin	ations l

ORDERING INFORMATION (Example)										
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION							
VS-8EWH06FN-M3	75	3000	Antistatic plastic tube							
VS-8EWH06FNTR-M3	2000	2000	13" diameter reel							
VS-8EWH06FNTRL-M3	3000	3000	13" diameter reel							
VS-8EWH06FNTRR-M3	3000	3000	13" diameter reel							

LINKS TO RELATED DOCUMENTS									
Dimensions	www.vishay.com/doc?95627								
Part marking information	www.vishay.com/doc?95176								
Packaging information	www.vishay.com/doc?95033								
SPICE model	www.vishay.com/doc?96114								







D-PAK (TO-252AA) "M"

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES		SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STNIDUL	MIN.	MAX.	MIN.	MAX.		STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES	
А	2.18	2.39	0.086	0.094			е	2.29	BSC	0.090	BSC	
A1	-	0.13	-	0.005			Н	9.40	10.41	0.370	0.410	
b	0.64	0.89	0.025	0.035			L	1.40	1.78	0.055	0.070	
b2	0.76	1.14	0.030	0.045			L1	2.74	BSC	0.108	REF.	
b3	4.95	5.46	0.195	0.215	3		L2	0.51	BSC	0.020	BSC	
с	0.46	0.61	0.018	0.024			L3	0.89	1.27	0.035	0.050	3
c2	0.46	0.89	0.018	0.035			L4	-	1.02	-	0.040	
D	5.97	6.22	0.235	0.245	5		L5	1.14	1.52	0.045	0.060	2
D1	5.21	-	0.205	-	3		Ø	0°	10°	0°	10°	
E	6.35	6.73	0.250	0.265	5		Ø1	0°	15°	0°	15°	
E1	4.32	-	0.170	-	3		Ø2	25°	35°	25°	35°	

#### Notes

<sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994

<sup>(2)</sup> Lead dimension uncontrolled in L5

<sup>(3)</sup> Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad

(4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip

(5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(6)</sup> Dimension b1 and c1 applied to base metal only

<sup>(7)</sup> Datum A and B to be determined at datum plane H

<sup>(8)</sup> Outline conforms to JEDEC<sup>®</sup> outline TO-252AA



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